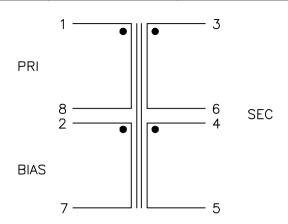


SUGGESTED PAD LAYOUT

UNLESS OTHERWISE SPECIFIED ALL TOLERANCES ARE ±0.25mm

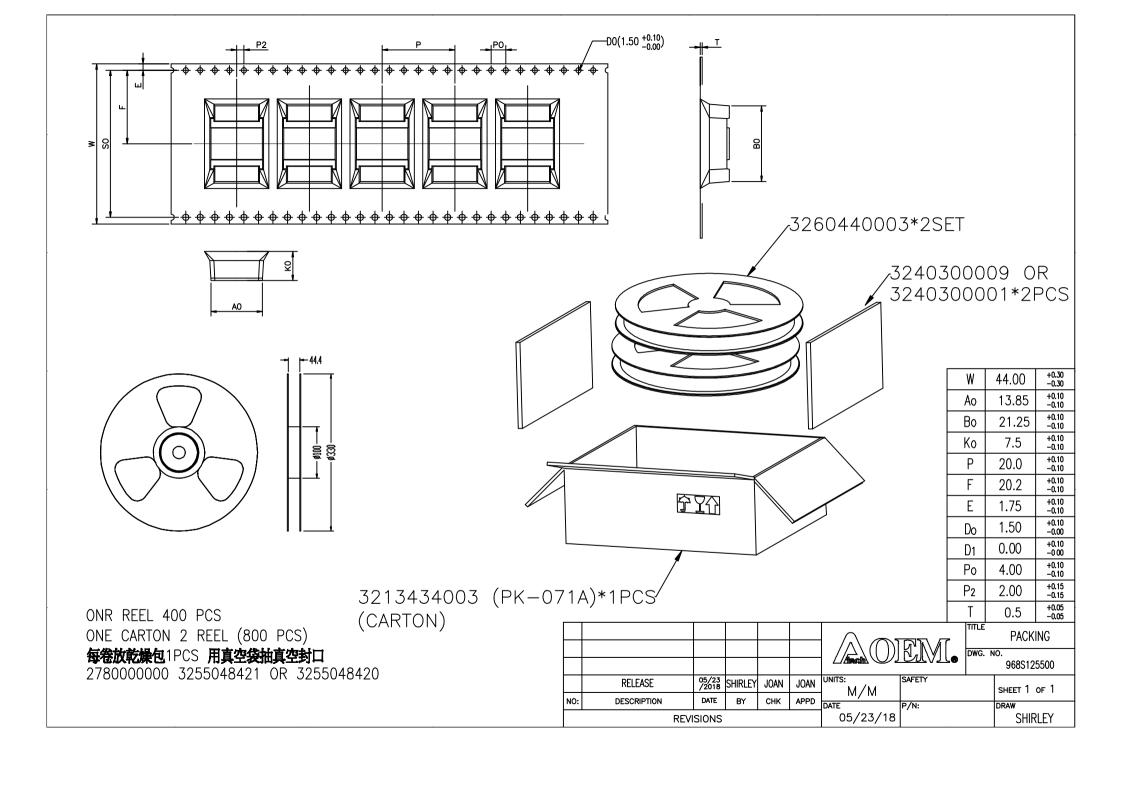


* RoHS COMPLIANCE

ELECTRICAL CHARACTERISTICS:

- 1. INDUCTANCE (@250KHz, 0.1Vrms) PIN $1-8 = 36uH \pm 10\%$
- \triangle 2. LEAKAGE INDUCTANCE (@250kHz, 0.1Vrms) PIN 1-8 = 0.7uH MAX. (PIN 2,3,4,5,6,7 SHORT)
 - 3. TURN RATIO (@250KHz, 0.1Vrms)
 PIN 1-8: 2-7 = 2.625 ±3%
 PIN 1-8: 3-6 = 2.625 ±3%
 PIN 1-8: 4-5 = 2.625 ±3%
 - 4. DCR : PIN $1-8 = 155m\Omega$ MAX. PIN $2-7 = 250m\Omega$ MAX. PIN $3-6 = 35m\Omega$ MAX. PIN $4-5 = 40m\Omega$ MAX.
- ₾ 5. HI-POT (@1500VAC, 1mA, 1S) : PIN(1-3) ; PIN 6-4 SHORT

С	ADD LEAKAGE INDUCTANCE	/2010	SHIRLEY	BETTY	BETTY		<u> </u>	TITLE	TRANSFORMER
В	CHANGE DIM. & ELECTRICAL CHARACTERISTICS	06/04 /2013	SHIRLEY	BETTY	BETTY			DWG. N	10
Α	CHANGE LOGO	54/23 /2013	SHIRLEY	BETTY	BETTY		<u> </u>		ATS-1235R
	RELEASE	04/24 /2013	SHIRLEY	BETTY	BETTY	UNITS: M/M	SAFETY		SHEET 1 OF 1
NO:	DESCRIPTION	DATE	BY	СНК	APPD	,	P/N:		DRAW
	REVI		04/24/13			Shirley			





Pb-free Soldering IR Reflow(SMD)



1,MSL Grade: 1 Level 2,Floor life: 2years 3,Condition:≤30°C RH 85% 2,Form-1(Reference JEDEC J-STD-020D Table 5-2)

	IR reflow profile	Pb-free	
step#	Profile Feature	Condition/Duration	
step1	Ramp-up rate	3°C/second max	
step2	Preheat:150°C-200°C(Ta-Tb)	t1-t2:60-120seconds	
step3	Ramp-up rate(TL to Tp)	3°C/second max	
sieps	Temperature maintained above 217°C	60-150seconds	
ston/	Peak temperature(Tp)	260+0/-5°C	
step4	Time within 5°C of actual peak temperature	30seconds max	
	Ramp-down rate(Tp to TL)	6°C/second max	

3,Form-2(Reference JEDEC J-STD-020D Table 4-2)

Package	Volume mm ³	Volume mm ³	Volume mm ³	
Thickness	<350	350-2000	>2000	
<1.6mm	260+0/-5°C	260+0/-5°C	260+0/-5℃	
1.6mm-2.5mm	260+0/-5°C	250+0/-5°C	245+0/-5℃	
>2.5mm	250+0/-5° C	245+0/-5°C	245+0/-5℃	